

Vishay Siliconix

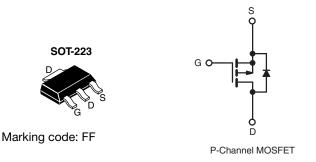
COMPLIANT

HALOGEN

FREE

Power MOSFET

PRODUCT SUMMA	RY	
V _{DS} (V)	-10	0
$R_{DS(on)}(\Omega)$	V _{GS} = -10 V	1.2
Q _g (Max.) (nC)	8.7	
Q _{gs} (nC)	2.2	
Q _{gd} (nC)	4.1	
Configuration	Sing	le



FEATURES

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- · Repetitive avalanche rated
- P-channel
- · Fast switching
- Ease of paralleling
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The SOT-223 package is designed for surface-mount using vapor phase, infrared, or wave soldering techniques. Its unique package design allows for easy automatic pick-and-place as with other SOT or SOIC packages but has the added advantage of improved thermal performance due to an enlarged tab for heatsinking. Power dissipation of greater than 1.25 W is possible in a typical surface mount application.

ORDERING INFORMATION		
Package	SOT-223	SOT-223
Lead (Pb)-free and Halogen-free	SiHFL9110-GE3	SiHFL9110TR-GE3 a
Lead (Pb)-free	IRFL9110PbF	IRFL9110TRPbF ^a
	SiHFL9110-E3	SiHFL9110T-E3 a

Note

a. See device orientation.

ABSOLUTE MAXIMUM RATINGS (To	; = 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage		V_{DS}	-100	V		
Gate-Source Voltage		V_{GS}	± 20	v		
Continuous Drain Current	V at 10.V	T _C = 25 °C	1	-1.1		
Continuous Drain Current	V _{GS} at - 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	I _D	-0.69	A	
Pulsed Drain Current ^a			I _{DM}	-8.8		
Linear Derating Factor				0.025	W/°C	
Linear Derating Factor (PCB Mount) e				0.017	- W/ C	
Single Pulse Avalanche Energy b			E _{AS}	100	mJ	
Avalanche Current a			I _{AR}	-1.1	Α	
Repetitive Avalanche Energy ^a			E _{AR}	0.31	mJ	
Maximum Power Dissipation	T _C =	T _C = 25 °C		3.1	W	
Maximum Power Dissipation (PCB Mount) e	T _A =	T _A = 25 °C		2.0	VV	
Peak Diode Recovery dV/dt c	•		dV/dt	-5.5	V/ns	
Operating Junction and Storage Temperature Range	ge		T _J , T _{stg}	-55 to +150	°C	
Soldering Recommendations (Peak Temperature)	for	10 s	_	300		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. V_{DD} = -25 V, starting T_J = 25 °C, L = 7.7 mH, R_g = 25 Ω , I_{AS} = -4.4 A (see fig. 12).
- c. $I_{SD} \le -4.4 \text{ A}$, $dI/dt \le -75 \text{ A/}\mu\text{s}$, $V_{DD} \le V_{DS}$, $T_J \le 150 \,^{\circ}\text{C}$.
- d. 1.6 mm from case.
- e. When mounted on 1" square PCB (FR-4 or G-10 material).



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THERMAL RESISTANCE RATI	NGS				
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient (PCB Mount) ^a	R _{thJA}	-	-	60	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1	40	

Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static							
Drain-Source Breakdown Voltage	V_{DS}	V _{GS} =	= 0 V, I _D = -250 μA	-100	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I _D = -1 mA	-	-0.091	-	V/°C
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = -250 μA	-2.0	-	-4.0	V
Gate-Source Leakage	I_{GSS}		$V_{GS} = \pm 20 \text{ V}$	1	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}		-100 V, V _{GS} = 0 V V, V _{GS} = 0 V, T _J = 125 °C	-	-	-100 - 500	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = -10 V		-	-	1.2	Ω
Forward Transconductance	9 _{fs}		-50 V, I _D = -0.66 A	0.82		-	S
Dynamic					l	l	
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	200	-	
Output Capacitance	C _{oss}		V _{GS} = 0 V, V _{DS} = - 25 V, f = 1.0 MHz, see fig. 5		94	-	рF
Reverse Transfer Capacitance	C _{rss}	f = 1			18	-	1
Total Gate Charge	Qq			-	-	8.7	
Gate-Source Charge	Q _{gs}	$V_{GS} = -10 \text{ V}$ $I_D = -4.0 \text{ A}, V_{DS} = -80 \text{ V},$ see fig. 6 and 13 b		-	-	2.2	nC
Gate-Drain Charge	Q _{gd}		See lig. 0 and 10	-	-	4.1	1
Turn-On Delay Time	t _{d(on)}			-	10	-	
Rise Time	t _r	V_{DD} = -50 V, I_{D} = -4.0 A, R_{G} = 24 Ω , R_{D} = 11 Ω , see fig. 10 b		-	27	-	ns
Turn-Off Delay Time	t _{d(off)}			-	15	-	
Fall Time	t _f			-	17	-	
Internal Drain Inductance	L_D		Between lead, 6 mm (0.25") from		4.0	-	
Internal Source Inductance	L _S	package and center of die contact		-	6.0	-	- nH
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		1	-	-1.1	Α
Pulsed Diode Forward Current ^a	I _{SM}	integral revers p - n junction	· · ·	-	-	-8.8	^
Body Diode Voltage	V _{SD}	T _J = 25 °C,	$I_S = -1.1 \text{ A}, V_{GS} = 0 \text{ V}^{\text{ b}}$	-	-	-5.5	V
Body Diode Reverse Recovery Time	t _{rr}	T 05 °C 1	4.0.4 dl/d+ 400.4/: h	-	80	160	ns
Body Diode Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = -4.0 \text{A}, dI/dt = 100 \text{A}/\mu \text{s}^{ \text{b}}$		-	0.15	0.30	μC
Forward Turn-On Time	t _{on}	Intrinsic tu	ırn-on time is negligible (turn	on is dor	ninated b	y L _S and	L _D)

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width $\leq 300~\mu s;$ duty cycle $\leq 2~\%.$



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

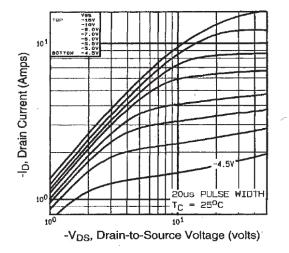


Fig. 1 - Typical Output Characteristics

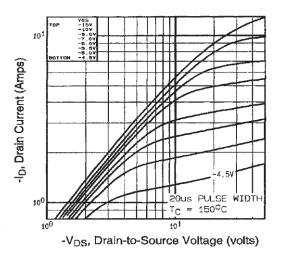


Fig. 2 - Typical Output Characteristics

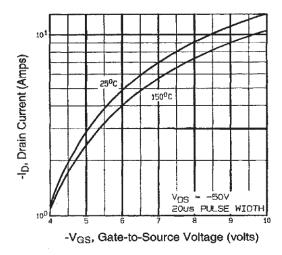


Fig. 3 - Typical Transfer Characteristics

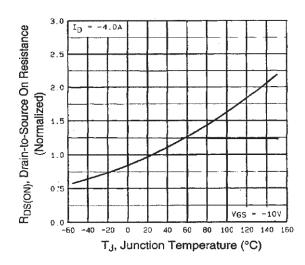


Fig. 4 - Normalized On-Resistance vs. Temperature



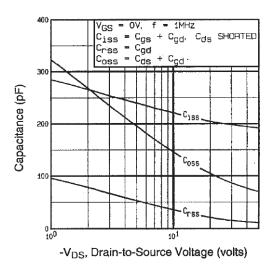


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

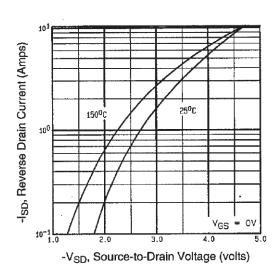


Fig. 7 - Typical Source-Drain Diode Forward Voltage

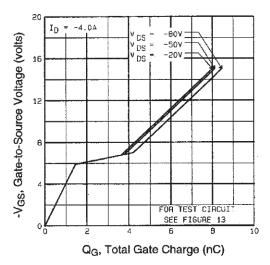


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

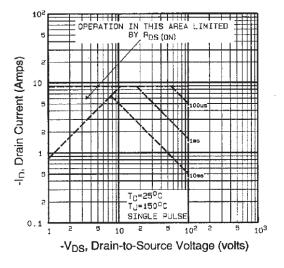


Fig. 8 - Maximum Safe Operating Area



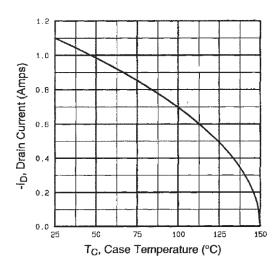


Fig. 9 - Maximum Drain Current vs. Case Temperature

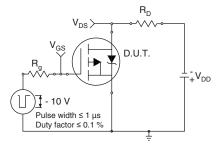


Fig. 10a - Switching Time Test Circuit

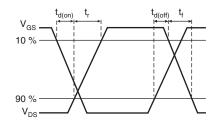


Fig. 10b - Switching Time Waveforms

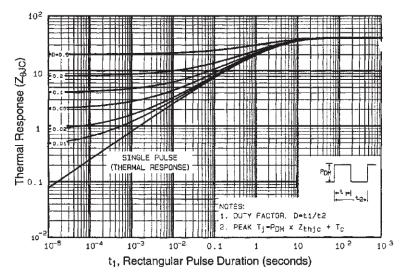


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



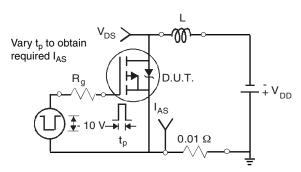


Fig. 12a - Unclamped Inductive Test Circuit

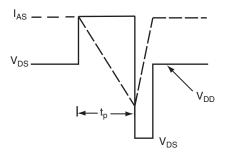


Fig. 12b - Unclamped Inductive Waveforms

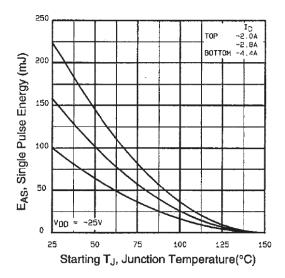


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

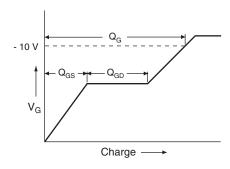


Fig. 13a - Basic Gate Charge Waveform

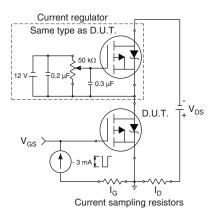
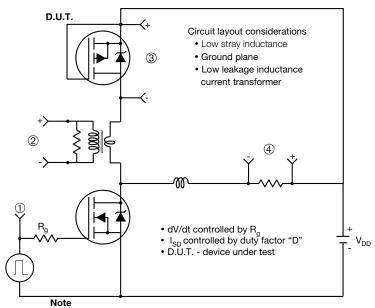


Fig. 13b - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver

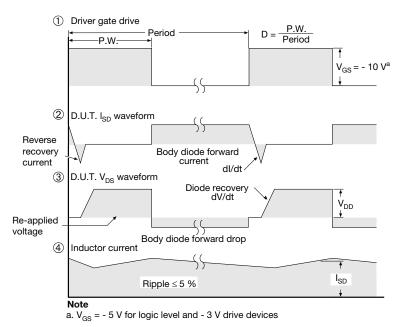


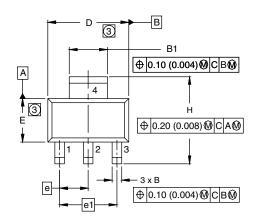
Fig. 14 - For P-Channel

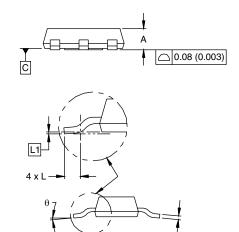
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SOT-223 (HIGH VOLTAGE)





DIM.	MILLI	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
E	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.0905	BSC	
e1	4.60 BSC		0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	=	
L1	0.061 BSC		0.0024	BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.



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